IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of :

Satoshi SENDAI et al. :

Serial No. NEW : **Attn: APPLICATION BRANCH**

Filed October 16, 2003 : Attorney Docket No. 2003-1488

PLATING APPARATUS AND METHOD
(Rule 1.53(b) Divisional of Serial No. 09/706,756, Filed November 7, 2000)

CLAIM OF PRIORITY UNDER 35 USC 119

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicants in the above-entitled application hereby claim the date of priority under the International Convention of Japanese Patent Application No. 11-316767, filed November 8, 1999, and Japanese Patent Application No. 2000-145682, filed May 17, 2000, as acknowledged in the Declaration of this application.

Certified copies of said Japanese Patent Applications are of record in parent application Serial No. 09/706,756, filed November 7, 2000.

Respectfully submitted,

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